



Click [here](#) for the 3D model.

#### General Information

Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
Termination	Flexible Termination With Lead (SnPb)
Marking	false
AEC-Q200	No
Typical Component Weight	70 mg
Shelf Life	78 Weeks
MSL	1

#### Dimensions

Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
T	1.7mm +/-0.20mm
S	1.5mm MIN
B	0.6mm +/-0.25mm

#### Packaging Specifications

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	8000

#### Specifications

Capacitance	51 pF
Measurement Condition	1MHz 1.0Vrms
Capacitance Tolerance	2%
Voltage DC	1500 VDC
Dielectric Withstanding Voltage	1800 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms